502689901 02/21/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE: ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
CHEN-HUNG LU	02/17/2014
CHIE-IUAN LIN	02/17/2014
YEN-SEN WANG	02/17/2014
MING-YI LIN	02/17/2014
JYH-KANG TING	02/17/2014

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LIMITED	
Street Address:	NO. 8, LI-HSIN ROAD 6	
Internal Address:	HSIN-CHU SCIENCE PARK	
City:	HSIN-CHU	
State/Country:	TAIWAN	
Postal Code:	300-77	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number: 14186141		

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: TSMC2013-1877

PATENT

502689901 REEL: 032266 FRAME: 0814

NAME OF SUBMITTER:	MARCUS A. FISCHER	
Signature:	/Marcus A. Fischer/	
Date:	02/21/2014	
Total Attachments: 2 source=TSMC2013-1877-Assignment#page1.tif source=TSMC2013-1877-Assignment#page2.tif		

PATENT REEL: 032266 FRAME: 0815

ASSIGNMENT

For good and valuable consideration received of the hereinafter named assignee, receipt of which is hereby acknowledged, the undersigned

Chen-Hung Lu Hsinchu City, TW Chie-Iuan Lin Zhubei City, TW

Yen-Sen Wang Hsinchu City, TW

Ming-Yi Lin Hsinchu City, TW Jyh-Kang Ting Baoshan Township, TW

NOW, THEREFORE, for and in consideration of our employment and the salary or wages paid to us by Taiwan Semiconductor Manufacturing Company Limited, I/we, Chen-Hung Lu, Chie-Iuan Lin, Yen-Sen Wang, Ming-Yi Lin, and Jyh-Kang Ting, by these presents do sell, assign, and transfer unto said Taiwan Semiconductor Manufacturing Company Limited, a corporation organized and existing under the laws of the Republic of China, having its principal place of business at No. 8, Li-Hsin Road 6, Hsin-Chu Science Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring an interest therein, its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries, in and to the inventions entitled

SEMICONDUCTOR ARRANGEMENT AND FORMATION THEREOF

for which application for United States Letters Patent has been filed on _____ Serial No. , or was executed by the undersigned on the date below and is being filed concurrently herewith, said application for United States Letters Patent, any and all other applications for Letters Patent on said inventions in countries foreign to the United States, including all divisional, renewal, substitute, continuation and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues and extensions of Letters Patent granted for said inventions or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said applications and said Letters Patent; said assignee being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said assignee or otherwise as said assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments being hereby authorized to issue or transfer all said Letters Patent to said assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right heretofore given, and that the undersigned will do all acts reasonably serving to assure that said inventions, patent applications and Letters Patent shall be held and enjoyed by said assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, and lawful affidavits in form

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and substance which may be requested by said assignee, to furnish said assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said inventions, and to testify in any proceedings relating to said inventions, patent applications and Letters Patent.

Chen-Hung Lu Inventor's Signature Chen-Hung Lu Printed Name in English	✓ 2014 / 02/\$1 Date
✓ Ohie-Inan Lin Inventor's Signature	Date >014/.02/17
Chie-Iuan Lin Printed Name in English	
Inventor's Signature Yen-Sen Wang Printed Name in English	Date
Inventor's Signature	ν γο(4/2/17 Date
Ming-Yi Lin Printed Name in English	
Jyh-l(ay Ty' Inventor's Signature	Date 2018/2/17
Jyh-Kang Ting Printed Name in English	